Customer No.: 31561 Application No.: 10/063,976

Docket No.: 7287-US-PA

**REMARKS** 

**Present Status of the Application** 

Claim 1-13 are allowed. The Office Action rejected presently pending claims 14-20.

Specifically, the Office Action rejected claims 14-20 under 35 U.S.C. 103(a), as being

unpatentable over Onitsuka et al. (U. S. Patent 6,049,167) in view of Vinouze et al. (U.S. Patent

5,326,420). Claims 8-14 remain pending in the present application, and reconsideration of those

claims is respectfully requested.

**Discussion of Office Action Rejections** 

The Office Action rejected claims 14-20 under 35 U.S.C. 103(a), as being unpatentable

over Onitsuka et al. in view of Vinouze et al. Applicants respectfully traverse the rejections for at

least the reasons set forth below.

In Applicants' invention, a trench is formed at an edge of a lamination plate to prevent

overflow of the sealing agent after a subsequent lamination process, and control the dimension of

the UV or thermal curing resin. Therefore, the adhesion between the UV or thermal curing resin,

the lamination plate, and the substrate will be improved by the global coating effect as mentioned

on lines 2-3, para.22 and in the summary of the invention, para.8. Independent claim 14 recites

the features as follows:

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14. A package apparatus for an organic electro-luminescent display, comprising at least:

comprising at least.

a panel supply system, to provide a panel comprising an organic electro-

luminescent display thereon;

a sealing agent coating system, to interpose a certain amount of a sealing

agent between the panel and a lamination plate;

a lamination plate supply system, to provide the lamination plate which

further comprises a trench formed at a periphery thereon;

an alignment and lamination system, to align and laminate the lamination

plate and the panel; and

a curing system, to cure the sealing agent.

(Emphasis added).

However, both Onitsuka and Vinouze were never before recognized the problem and

mean solved by present invention. Although Vinouze teaches the lamination plate having a

groove on lines 46-49 of col.2, the groove is used as a suction device for holding substrates

instead of controlling the width of sealant by forming a gap in present invention. "The claimed

invention must be considered as a whole, and the question is whether there is something in the

prior art as a whole to suggest the desirability, and thus the obviousness, of making the

combination." Maschinenfabrik GMBH v. American Hoist & Derrick, 221 U.S.P.Q.481, 488

(Fed.Cir.1984). The recognition of an unrecognized problem militates in favor of patentability.

On the other hand, the lamination plate disclosed on lines 6-13 of col.5 of Onitsukas'

invention consisted of a rectangular top member (D21) and a side wall (D22) as illustrated in

figure 1. However, the lamination plate in present invention is a flat plate of glass without side

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walls and includes a groove formed at an edge thereof to prevent overflow of the sealant after a

subsequent lamination process. A side wall element of the prior-art device has been omitted

without loss of capability. It militates non-obvious.

As described previously, Onitsuka and Vinouze failed to disclose the features of "a

lamination plate supply system, to provide the lamination plate which further comprises a

trench formed at a periphery thereon" as recited in independent claim 14. Meanwhile, if the

combination of Onitsuka and Vinouze is made, the references would produce an inoperative

combination..

For at least the foregoing reasons, Applicants respectfully submit that independent claim

14 patently defines over the prior art references, and should be allowed. For at least the same

reasons; dependent claims 15-20 patently define over the prior art as well.

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CONCLUSION

The abovementioned facts fully support the patentability of the pending claims 14-20.

Accordingly, it is most respectfully requested that this rejection be withdrawn. The Examiner is

invited to call the undersigned to facilitate the advancement of the above-identified patent

application.

Date:

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Respectfully submitted,

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